Chipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

FAIRCHILD

SEMICONDUCTOR ™

May 1988
Revised October 2000

74F379
Quad Parallel Register with Enable

General Description

The 74F379 is a 4-bit register with buffered common Enable. This device is similar to the 74F175 but features the common Enable rather than common Master Reset.

Features

■ Edge triggered D-type inputs

■ Buffered positive edge-triggered clock

■ Buffered common enable input

■ True and complement outputs

Ordering Code:

Order Number	Package Number	Package Description
74F379SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
74F379SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F379PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols
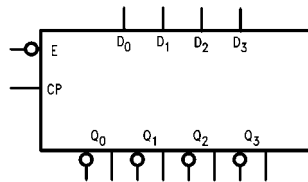
IEEE/IEC

Connection Diagram
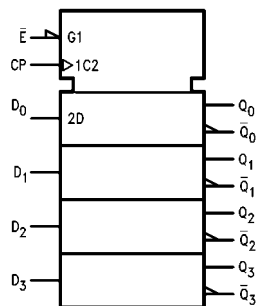
DS009527   www.fairchildsemi.com

Unit Loading/Fan Out

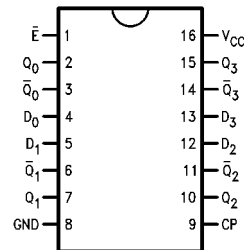| Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
$\overline{E}$	Enable Input (Active LOW)	1.0/1.0	20 µA/−0.6 mA
D_0–D_3	Data Inputs	1.0/1.0	20 µA/−0.6 mA
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 µA/−0.6 mA
Q_0–Q_3	Flip-Flop Outputs	50/33.3	−1 mA/20 mA
$\overline{Q}_0$–$\overline{Q}_3$	Complement Outputs	50/33.3	−1 mA/20 mA

Functional Description

The 74F379 consists of four edge-triggered D-type flip-flops with individual D inputs and Q and $\overline{Q}$ outputs. The Clock (CP) and Enable ($\overline{E}$) inputs are common to all flip-flops. When the $\overline{E}$ is input HIGH, the register will retain the present data independent of the CP input. The D_n and $\overline{E}$ inputs can change when the clock is in either state, provided that the recommended setup and hold times are observed.

Truth Table

Inputs			Outputs	
$\overline{E}$	CP	D_n	Q_n	$\overline{Q}_n$
H	⌐	X	NC	NC
L	⌐	H	H	L
L	⌐	L	L	H

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial
⌐ = LOW-to-HIGH Transition
NC = No Change

Logic Diagram
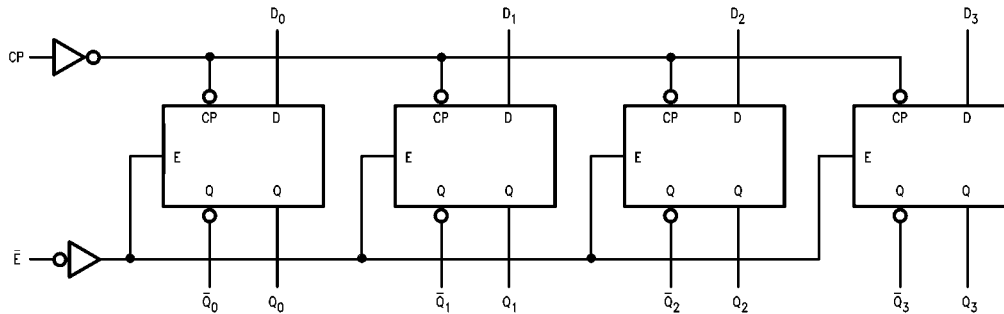
Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Storage Temperature	−65°C to +150°C
Ambient Temperature under Bias	−55°C to +125°C
Junction Temperature under Bias	−55°C to +150°C
V_{CC} Pin Potential to Ground Pin	−0.5V to +7.0V
Input Voltage (Note 2)	−0.5V to +7.0V
Input Current (Note 2)	−30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with V_{CC} = 0V)	
Standard Output	−0.5V to V_{CC}
3-STATE Output	−0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)
ESD Last Passing Voltage (Min)	4000V

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.
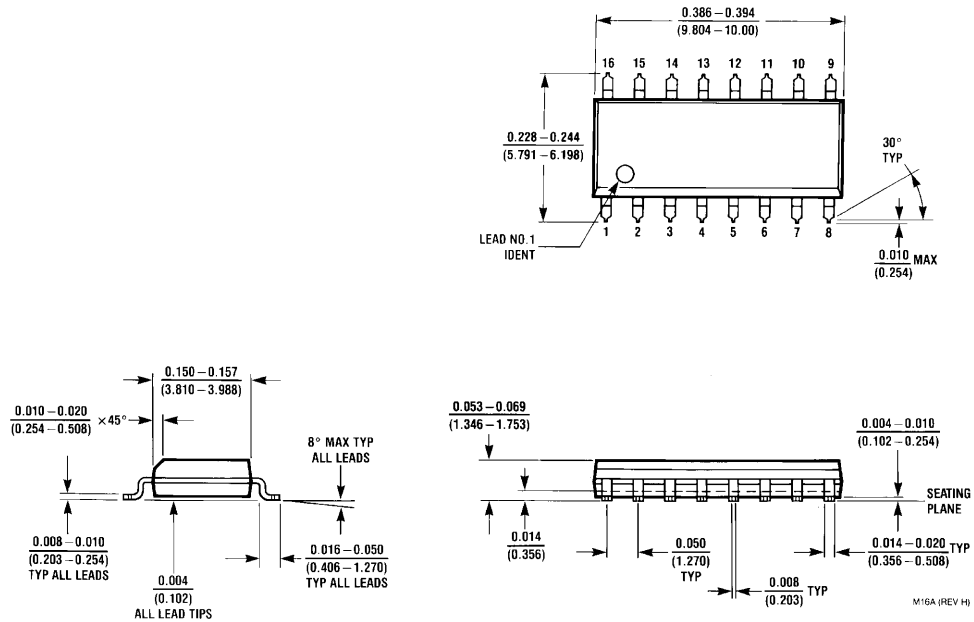
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Voltage				−1.2	V	Min	I_{IN} = −18 mA
V_{OH}	Output HIGH	10% V_{CC}	2.5			V	Min	I_{OH} = −1 mA
	Voltage	5% V_{CC}	2.7					I_{OH} = −1 mA
V_{OL}	Output LOW Voltage	10% V_{CC}			0.5	V	Min	I_{OL} = 20 mA
I_{IH}	Input HIGH Current				5.0	µA	Max	V_{IN} = 2.7V
I_{BVI}	Input HIGH Current Breakdown Test				7.0	µA	Max	V_{IN} = 7.0V
I_{CEX}	Output HIGH Leakage Current				50	µA	Max	V_{OUT} = V_{CC}
V_{ID}	Input Leakage Test		4.75			V	0.0	I_{ID} = 1.9 µA All Other Pins Grounded
I_{OD}	Output Leakage Circuit Current				3.75	µA	0.0	V_{IOD} = 150 mV All Other Pins Grounded
I_{IL}	Input LOW Current				−0.6	mA	Max	V_{IN} = 0.5V
I_{OS}	Output Short-Circuit Current		−60		−150	mA	Max	V_{OUT} = 0V
I_{CCL}	Power Supply Current			28	40	mA	Max	V_O = LOW

AC Electrical Characteristics

Symbol	Parameter	$T_A = +25°C$ $V_{CC} = +5.0V$ $C_L = 50$ pF			$T_A = -55°C$ to $+125°C$ $V_{CC} = +5.0V$ $C_L = 50$ pF		$T_A = 0°C$ to $+70°C$ $V_{CC} = +5.0V$ $C_L = 50$ pF		Units
		Min	Typ	Max	Min	Max	Min	Max	
f_{MAX}	Maximum Clock Frequency	100	140		75		100		MHz
t_{PLH}	Propagation Delay	3.5	5.0	6.5	3.0	8.5	3.5	7.5	ns
t_{PHL}	CP to Q_n, $\overline{Q}_n$	5.0	6.5	8.5	4.0	10.0	5.0	9.5	

AC Operating Requirements

Symbol	Parameter	$T_A = +25°C$ $V_{CC} = +5.0V$		$T_A = -55°C$ to $+125°C$ $V_{CC} = +5.0V$		$T_A = 0°C$ to $+70°C$ $V_{CC} = +5.0V$		Units
		Min	Max	Min	Max	Min	Max	
$t_S(H)$	Setup Time, HIGH or LOW	3.0		4.0		3.0		ns
$t_S(L)$	D_n to CP	3.0		4.0		3.0		
$t_H(H)$	Hold Time, HIGH or LOW	1.0		2.0		1.0		
$t_H(L)$	D_n to CP	1.0		2.0		1.0		
$t_S(H)$	Setup Time, HIGH or LOW	6.0		8.0		6.0		ns
$t_S(L)$	$\overline{E}$ to CP	6.0		8.0		6.0		
$t_H(H)$	Hold Time, HIGH or LOW	0		0		0		
$t_H(L)$	$\overline{E}$ to CP	0		0		0		
$t_W(H)$	CP Pulse Width	4.0		5.0		4.0		ns
$t_W(L)$	HIGH or LOW	5.0		7.0		5.0		

Physical Dimensions inches (millimeters) unless otherwise noted

0.386 − 0.394
(9.804 − 10.00)

16 15 14 13 12 11 10 9

0.228 − 0.244
(5.791 − 6.198)

30°
TYP

LEAD NO.1
IDENT

1   2   3   4   5   6   7   8

0.010 MAX
(0.254)

0.150 − 0.157
(3.810 − 3.988)

0.010 − 0.020
(0.254 − 0.508) × 45°

8° MAX TYP
ALL LEADS

0.008 − 0.010
(0.203 − 0.254)
TYP ALL LEADS

0.004
(0.102)
ALL LEAD TIPS

0.016 − 0.050
(0.406 − 1.270)
TYP ALL LEADS

0.053 − 0.069
(1.346 − 1.753)

0.004 − 0.010
(0.102 − 0.254)

SEATING
PLANE

0.014
(0.356)

0.050
(1.270)
TYP

0.008
(0.203) TYP

0.014 − 0.020
(0.356 − 0.508) TYP

M16A (REV H)

16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

10.2±0.1
-A-

0.47 TYP

16   9

7.8

5.3±0.1
-B-

3.9

⌓ 0.2 C B A
ALL LEAD TIPS

PIN #1 IDENT.

1   8

16   15   10   9

5.01 TYP

9.27 TYP

(2.13 TYP)

1   2   7   8

1.27 TYP   0.6 TYP

LAND PATTERN RECOMMENDATION

ALL LEAD TIPS
⌓ 0.1 C

2.1 MAX.

1.8±0.1

-C-

0.15±0.05

1.27 TYP

0.35-0.51
⊕ 0.12 Ⓜ C A

DIMENSIONS ARE IN MILLIMETERS

SEE DETAIL A

0.15-0.25
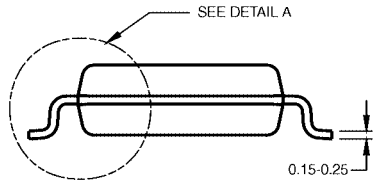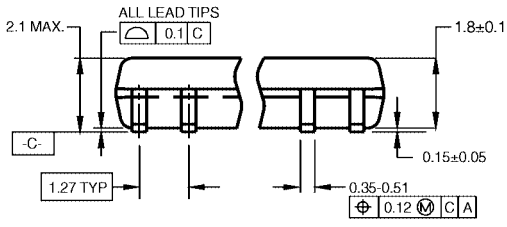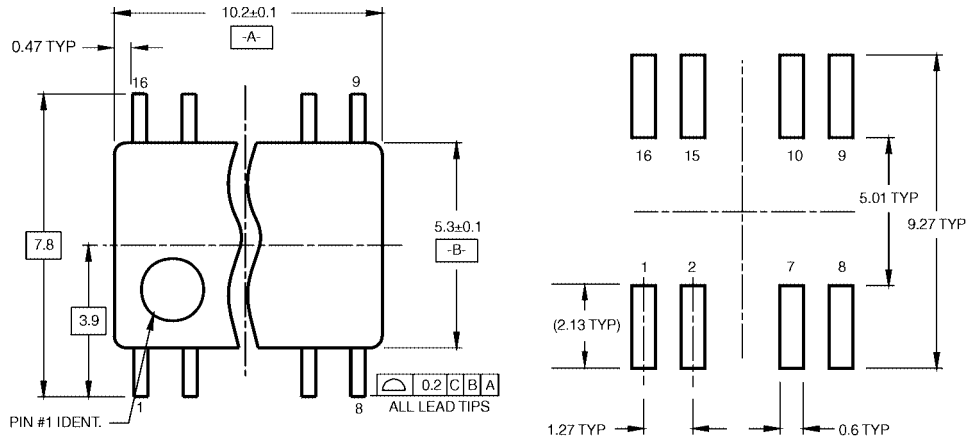
NOTES:
A. CONFORMS TO EIAJ EDR-7320 REGISTRATION,
   ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
   FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1

7° TYP

GAGE PLANE

0°-8° TYP

0.25

0.60±0.15

1.25

SEATING PLANE

DETAIL A
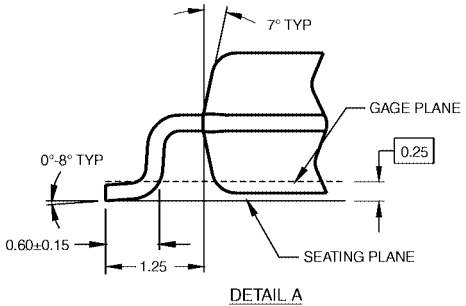
16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com